



12500 TI Boulevard, MS 8640, Dallas, Texas 75243

Notification Number:	20260924001.0	Notification Issued	September 25, 2026
Datasheet for ESD441			

Change Type(s)	Data Sheet/Electrical Specification
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Notification Details

Description of Change:		
Texas Instruments Incorporated is announcing an information only notification. The product datasheet(s) is being updated as summarized below. The following change history provides further details.		
		ESD441
		SLVSH26C – APRIL 2023 – REVISED AUGUST 2026
Changes from Revision B (December 2025) to Revision C (September 2026)		Page
• Changed min input pin voltage from -5.5V to 0V.....		4
• Removed 5.5V VRWM min limit.....		6
The datasheet number will be changing.		
Device Family	Change From:	Change To:
ESD441	SLVSH26B	SLVSH26C
These changes may be reviewed at the datasheet links provided.		
http://www.ti.com/product/ESD441		
Reason for Change:	To accurately reflect device characteristics	

Anticipated impact on Form, Fit, Function, Quality or Reliability:	None
Changes to product identification resulting from this PCN:	None

Products Affected:			
ESD441DPLR	ESD441DPLR.B	ESD441DPYR	

In performing change qualifications, Texas Instruments follows integrated circuit industry standards in performing defect mechanism analysis and failure mechanism-based accelerated environmental testing to ensure wafer fab process, assembly process and product quality and reliability. As encouraged by these standards, TI uses both product-specific and generic (family) data in qualifying its changes. For devices to be categorized as a 'product qualification family' for generic data purposes, they must share similar product, wafer fab process and

assembly process elements. The applicability of generic data (also known at TI as Qualification by Similarity (QBS)) is determined by the Reliability Engineering function following these industry standards. Generic data is shown in the qualification report in columns titled "QBS Process" (for wafer fab process), "QBS Package" (for assembly process) and "QBS Product" (for product family).

For questions regarding this notice, e-mails can be sent to the contact shown below or your local Field Sales Representative.

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